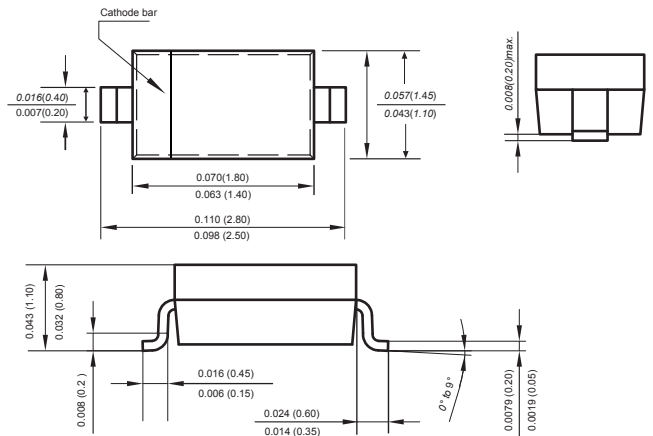


SURFACE MOUNT ULTRA FAST RECOVERY RECTIFIER

Features

- ◆ Low forward voltage drop
- ◆ Low leakage current
- ◆ Low profile package
- ◆ For surface mounted applications
- ◆ Glass Passivated Chip Junction
- ◆ Easy to pick and place
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives

SOD-323



Dimensions in inches and (millimeters)

Mechanical Data

Case: SOD-323

Terminals: Solderable per MIL-STD-750, Method 2026A

Polarity: Polarity symbol marking on body

Mounting Position: Any

Approx. Weight: 0.0019 ounce, 0.0548 grams

Maximum Ratings And Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.

Parameter	SYMBOLS	SOD05H1WS	SOD05H2WS	SOD05H3WS	SOD05H5WS	SOD05H6WS	SOD05H7WS	SOD05H8WS	UNITS	
Marking Code		U1	U2	U3	U5	U6	U7	U8		
Maximum repetitive peak reverse voltage	V_{RMM}	50	100	200	400	600	800	1000	V	
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V	
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V	
Maximum average forward rectified current at $T_c = 125^\circ C$	$I_{F(AV)}$	0.5							A	
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	15							A	
Maximum instantaneous forward voltage at 1.0A	V_F	1.0			1.30		1.65		V	
Maximum DC reverse current $T_A=25^\circ C$ at rated DC blocking voltage $T_A=125^\circ C$	I_R	5 100							μA	
Typical junction capacitance (NOTE 3)	C_J	8							pF	
Typical reverse recovery time (NOTE 2)	T_{rr}	50				75				ns
Operating junction temperature range	T_J	-55 to +150							$^\circ C$	
Storage temperature range	T_{STG}	-55 to +150							$^\circ C$	

- Note:**
- 1.P.C.B. mounted with 0.2" X 0.2" (5 X 5 mm) copper pad areas.
 - 2.Measured with $I_F=0.5A, I_R=1A, I_{rr}=0.25A$
 - 3.Measured at 1.0MHz and applied reverse voltage of 4.0V D.C.
 - 4.The typical data above is for reference only.

Typical Characteristics

Fig.1 Forward Current Derating Curve

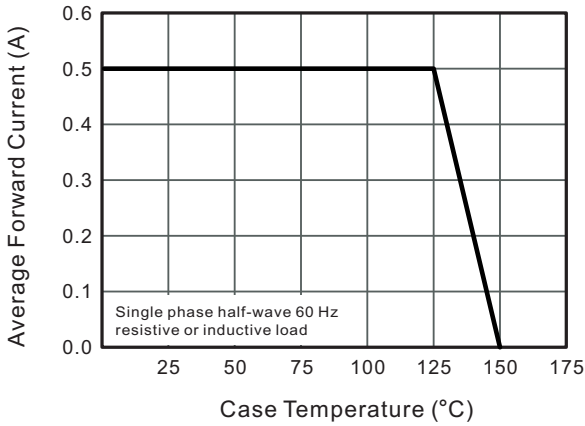


Fig.2 Typical Instaneous Reverse Characteristics

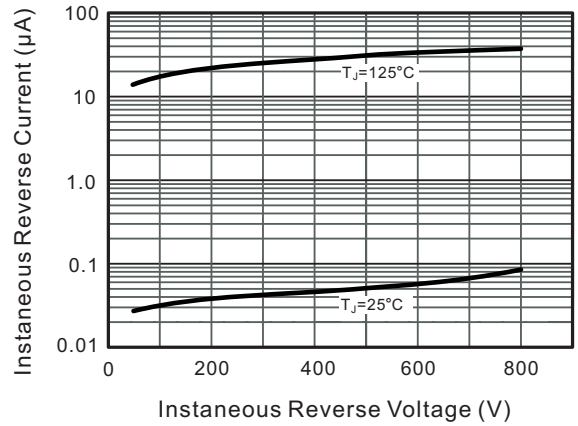


Fig.3 Typical Instaneous Forward Characteristics

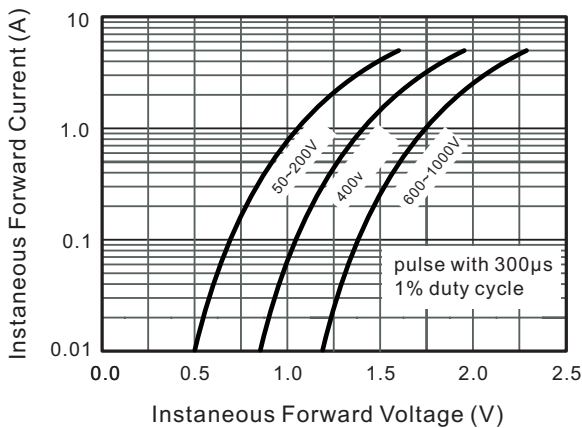


Fig.4 Typical Junction Capacitance

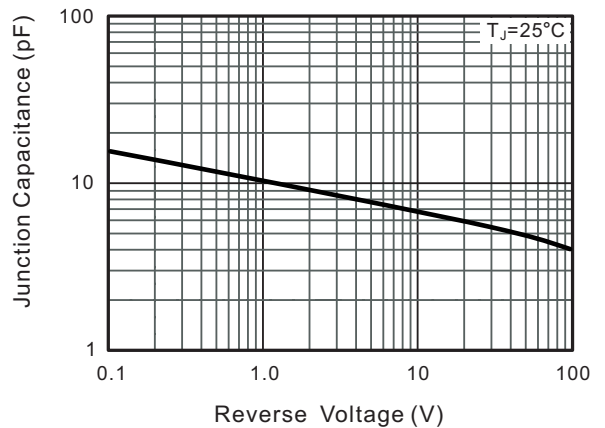
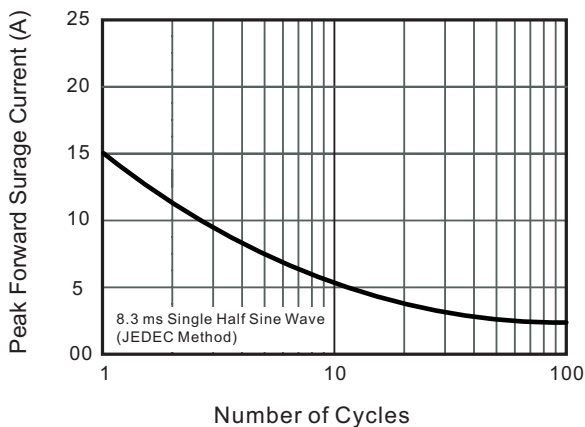
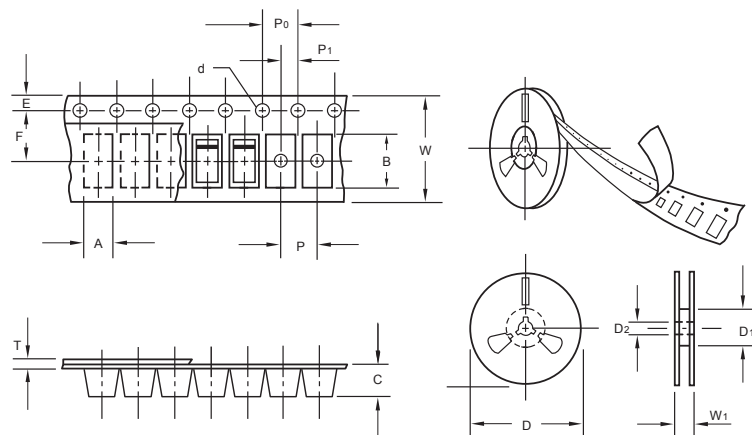


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



The curve above is for reference only.

Packing information



unit:mm

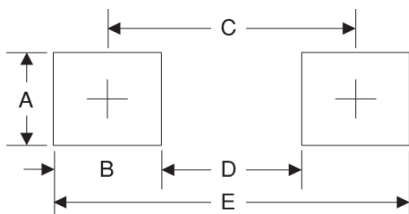
Item	Symbol	Tolerance	SOD-323
Carrier width	A	0.1	1.46
Carrier length	B	0.1	2.90
Carrier depth	C	0.1	1.25
Sprocket hole	d	0.05	1.50
13" Reel outside diameter	D	2.0	330.00
13" Reel inner diameter	D ₁	min	50.00
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D ₁	min	54.40
Feed hole diameter	D ₂	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P ₀	0.1	4.00
Embossment center	P ₁	0.1	2.00
Overall tape thickness	T	0.1	0.06
Tape width	W	0.3	8.00
Reel width	W ₁	1.0	12.30

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA. (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SOD-323	7"	3,000	4.0	45,000	210*208*203	178	430*430*235	180,000	9.0

Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	1.2	0.047
B	1.2	0.047
C	2.6	0.141
D	1.4	0.055
E	3.8	0.149